TOSHIBA CMOS Digital Integrated Circuit Silicon Monolithic

# TC74LCX541F, TC74LCX541FK

Low-Voltage Octal Bus Buffer with 5-V Tolerant Inputs and Outputs

The TC74LCX541 is a high-performance CMOS octal bus buffer. Designed for use in 3.3-V systems, it achieves high-speed operation while maintaining the CMOS low power dissipation.

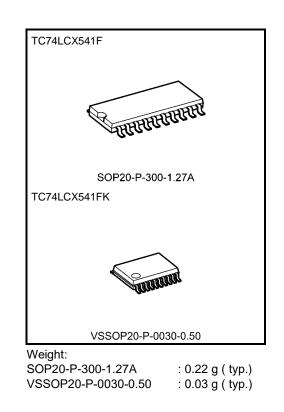
The device is designed for low-voltage (3.3 V)  $V_{\rm CC}$  applications, but it could be used to interface to 5 V supply environment for both inputs and outputs.

The TC74LCX541 is a non-inverting 3-state buffer having two activelow output enables. When either  $\overline{OE1}$  or  $\overline{OE2}$  are high, the terminal outputs are in the high-impedance state. This device is designed to be used with 3-state memory address drivers, etc.

All inputs are equipped with protection circuits against static discharge.

#### Features

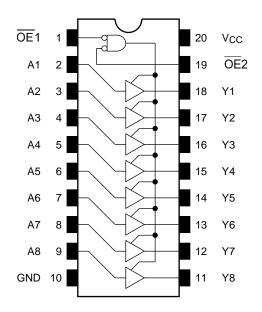
- Low-voltage operation: VCC = 1.65 to 3.6 V
- High-speed operation:  $t_{pd} = 6.5 \text{ ns} (max) (V_{CC} = 3.0 \text{ to } 3.6 \text{ V})$
- Output current:  $|I_{OH}|/I_{OL} = 24 \text{ mA} (min) (V_{CC} = 3.0 \text{ V})$
- Available in JEITA SOP, VSSOP (US)
- Power-down protection provided on all inputs and outputs
- Pin and function compatible with the 74 series (74AC/VHC/HC/F/ALS/LS etc.) 541 type



Note: The Electrical Characteristics of  $V_{CC}$  = 1.8 ± 0.15 V is only applicable for products which manufactured from January 2009 onward.

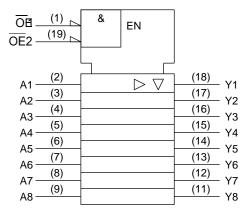
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## Pin Assignment (top view)



## Truth Table

	Outpute		
OE1	OE2	An	Outputs
Н	Х	Х	Z
Х	Н	Х	Z
L	L	Н	н
L	L	L	L



**IEC Logic Symbol** 

#### X: Don't care

Z: High impedance

#### Absolute Maximum Ratings (Note 1)

Characteristics	Symbol	Rating	Unit
Power supply voltage	Vcc	-0.5 to 7.0	V
DC input voltage	VIN	-0.5 to 7.0	V
		-0.5 to 7.0 (Note 2)	
DC output voltage	Vout	-0.5 to V <sub>CC</sub> + 0.5 (Note 3)	V
Input diode current	Ік	-50	mA
Output diode current	ЮК	±50 (Note 4)	mA
DC output current	Ιουτ	±50	mA
Power dissipation	PD	180	mW
DC V <sub>CC</sub> /ground current	ICC/IGND	±100	mA
Storage temperature	T <sub>stg</sub>	–65 to 150	°C

Note 1: Exceeding any of the absolute maximum ratings, even briefly, lead to deterioration in IC performance or even destruction.

Using continuously under heavy loads (e.g. the application of high temperature/current/voltage and the significant change in temperature, etc.) may cause this product to decrease in the reliability significantly even if the operating conditions (i.e. operating temperature/current/voltage, etc.) are within the absolute maximum ratings and the operating ranges.

Please design the appropriate reliability upon reviewing the Toshiba Semiconductor Reliability Handbook ("Handling Precautions"/"Derating Concept and Methods") and individual reliability data (i.e. reliability test report and estimated failure rate, etc).

- Note 2: Output in OFF state
- Note 3: High or low state. IOUT absolute maximum rating must be observed.
- Note 4: VOUT < GND, VOUT > VCC

#### **Operating Ranges (Note 1)**

Characteristics	Symbol	Rating	Unit	
	Vee	1.65 to 3.6		
Power supply voltage	Vcc	1.5 to 3.6 (Note 2)	V	
Input voltage	Vin	0 to 5.5	V	
Output voltage	Vout	0 to 5.5 (Note 3)	V	
Output voltage	VOUT	0 to V <sub>CC</sub> (Note 4)	v	
	rrent IOH/IOI ±24 (No		mA	
Output current	IOH/IOL	±12 (Note 6)	ША	
Operating temperature	Topr	-40 to 85	°C	
Input rise and fall time	dt/dv	0 to 10 (Note 7)	ns/V	

Note 1: The operating ranges must be maintained to ensure the normal operation of the device. Unused inputs must be tied to either V<sub>CC</sub> or GND.

Note 2: Data retention only

Note 3: Output in OFF state

Note 4: High or low state

Note 5: VCC = 3.0 to 3.6 V

- Note 6: VCC = 2.7 to 3.0 V
- Note 7: VIN = 0.8 to 2.0 V, VCC = 3.0 V

#### **Electrical Characteristics**

#### DC Characteristics (Ta = -40 to 85°C)

Characteris	Characteristics Symbol Test Condition		[	Min	Max	Unit			
		-			Vcc (V)				
					1.65 to 2.3	VCC×0.9			
	H-level	VIH		—		1.7			
Input voltage					2.7 to 3.6	2.0	_	V	
input voltage					1.65 to 2.3	—	Vcc×0.1	v	
	L-level	VIL			2.3 to 2.7	—	0.7		
					2.7 to 3.6		0.8		
				IOH = -100 μA	1.65 to 3.6	Vcc-0.2	_		
				$I_{OH} = -4 \text{ mA}$	1.65	1.05	_		
				Iон = -8 mA	2.3	1.7	_	· · · · · · · · · · · · · · · · · · ·	
	H-level	Vон	$V_{IN} = V_{IH} \text{ or } V_{IL}$	I <sub>OH</sub> = -12 mA	2.7	2.2	_		
				Iон = -18 mA	3.0	2.4			
O david v slike se				Iон = -24 mA	3.0	2.2			
Output voltage			VIN = VIH or VIL	I <sub>OL</sub> = 100 μA	1.65 to 3.6		0.2		
				IOL = 4 mA	1.65		0.45		
				IOL = 8 mA	2.3		0.7		
	L-level	Vol			I <sub>OL</sub> = 12 mA	2.7		0.4	
				I <sub>OL</sub> = 16 mA	3.0		0.4		
				IoL = 24 mA	3.0		0.55		
Input leakage current		lin	V <sub>IN</sub> = 0 to 5.5 V		1.65 to 3.6		±5.0	μΑ	
3-state output off-state	B-state output off-state current $I_{OZ}$ $V_{IN} = V_{IH} \text{ or } V_{IL}$ $V_{OUT} = 0 \text{ to } 5.5 \text{ V}$		1.65 to 3.6		±5.0	μΑ			
Power off leakage cur	rent	IOFF	VIN/VOUT = 5.5 V		0		10.0	μA	
			V <sub>IN</sub> = V <sub>CC</sub> or GND		1.65 to 3.6		10.0		
Quiescent supply curr	ent	Icc	$V_{IN}/V_{OUT} = 3.6$ to \$	/V <sub>OUT</sub> = 3.6 to 5.5 V			±10.0	μA	
Increase in ICC per in	put	ΔICC	VIH = VCC - 0.6 V	(per 1 input)	2.7 to 3.6	_	500		

#### AC Characteristics (Ta = -40 to 85°C)

Characteristics	Symbol	Test Condition		Min	Max	Unit
Characteristics	Symbol Test Condition		V <sub>CC</sub> (V)	IVIITI	IVIAX	Unit
			$\textbf{1.8}\pm\textbf{0.15}$	_	25.0	
Dran a nation dalay time	tpLH		$2.5\pm0.2$	_	8.5	
Propagation delay time	tpHL	Figure 1, Figure 2	2.7	_	7.5	ns
			$\textbf{3.3}\pm\textbf{0.3}$	1.5	6.5	
			$\textbf{1.8}\pm\textbf{0.15}$		34.0	ns
Output anable time	<sup>t</sup> pZL t <sub>pZH</sub> Figure 1, Figure 3	Figure 1, Figure 3	$2.5\pm0.2$	_	17.0	
Output enable time			2.7	_	9.5	
		$\textbf{3.3}\pm\textbf{0.3}$	1.5	8.5		
			$\textbf{1.8}\pm\textbf{0.15}$		32.0	
Outeut diachte time	tpLZ	Figure 1, Figure 3	$2.5\pm0.2$	_	16.0	
Output disable time	t <sub>pHZ</sub>		2.7	_	8.5	ns
			$\textbf{3.3}\pm\textbf{0.3}$	1.5	7.5	
	tosLH	() -+->	2.7			
Output to output skew	tosHL	(Note)	$\textbf{3.3}\pm\textbf{0.3}$		1.0	ns

Note: Parameter guaranteed by design.

(tosLH = |tpLHm - tpLHn|, tosHL = |tpHLm - tpHLn|)

#### Dynamic Switching Characteristics (Ta = 25°C, input: tr = tf = 2.5 ns, CL = 50 pF, RL = 500 $\Omega$ )

Characteristics	Symbol	Test Condition	V <sub>CC</sub> (V)	Тур.	Unit
Quiet output maximum dynamic $V_{OL}$	VOLP	$V_{IH}=3.3~V,~V_{IL}=0~V$	3.3	0.8	V
Quiet output minimum dynamic $V_{OL}$	Volv	$V_{IH}=3.3~V,~V_{IL}=0~V$	3.3	0.8	V

#### **Capacitive Characteristics (Ta = 25°C)**

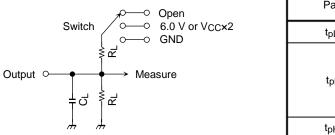
Characteristics	Symbol	Test Condition	V <sub>CC</sub> (V)	Тур.	Unit
Input capacitance	CIN	_	3.3	7	pF
Output capacitance	Соит	_	3.3	8	pF
Power dissipation capacitance	Cpd	f <sub>IN</sub> = 10 MHz (Note	) 3.3	40	pF

Note: CPD is defined as the value of the internal equivalent capacitance which is calculated from the operating current consumption.

Average operating current can be obtained by the equation: ICC (opr) = CPD  $\cdot$  VCC  $\cdot$  fIN + ICC/8 (per bit)



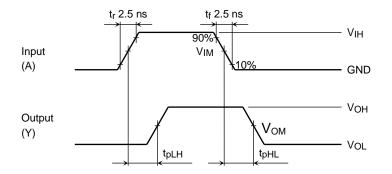
### **AC Test Circuit**

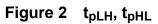


Parameter	Switch		
tpLH, tpHL	Open		
	6.0 V @ V <sub>CC</sub> =3.3±0.3V @ V <sub>CC</sub> =2.7V		
tpLZ, tpZL	V <sub>CC</sub> ×2 @ V <sub>CC</sub> =2.5±0.2V @ V <sub>CC</sub> =1.8±0.15V		
t <sub>pHZ</sub> , t <sub>pZH</sub>	GND		

Figure 1

## AC Waveform





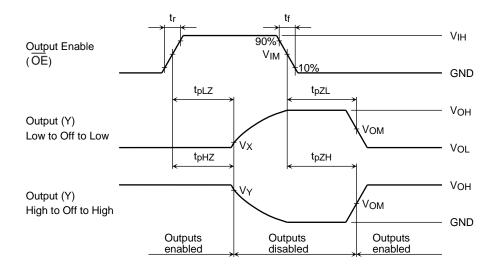


Figure 3  $t_{pLZ}$ ,  $t_{pHZ}$ ,  $t_{pZL}$ ,  $t_{pZH}$ 

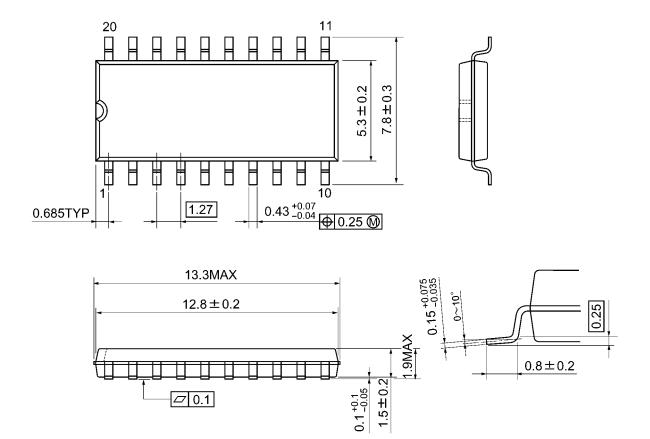
		V <sub>CC</sub>				
	Symbol	3.3 ± 0.3 V 2.7 V	$2.5\pm0.2\;\text{V}$	$1.8\pm0.15~\text{V}$		
Input	VIH	2.7 V	V <sub>CC</sub>	V <sub>CC</sub>		
	VIM	1.5 V	V <sub>CC</sub> /2	V <sub>CC</sub> /2		
	tr,tf	2.5 ns	2.0 ns	2.0 ns		
Output	Vom	1.5 V	V <sub>OH</sub> /2	V <sub>OH</sub> /2		
	VX	V <sub>OL</sub> +0.3 V	V <sub>OL</sub> +0.15 V	V <sub>OL</sub> +0.15 V		
	Vy	V <sub>OH</sub> -0.3 V	V <sub>OH</sub> -0.15 V	V <sub>OH</sub> -0.15 V		
Load	CL	50 pF	30 pF	30 pF		
	RL	500 Ω	500 Ω	1 kΩ		



#### **Package Dimensions**

SOP20-P-300-1.27A

Unit: mm



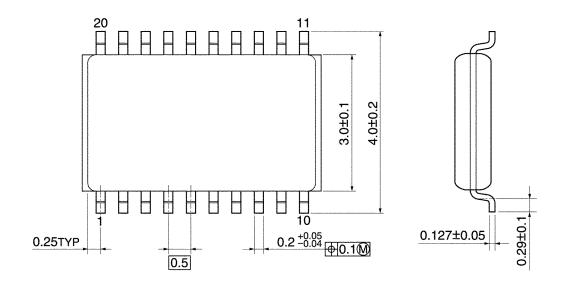
Weight: 0.22 g (typ.)

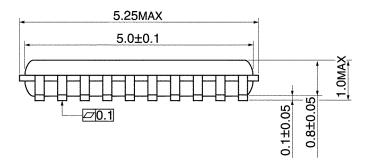


#### **Package Dimensions**

VSSOP20-P-0030-0.50

Unit: mm





Weight: 0.03 g (typ.)

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